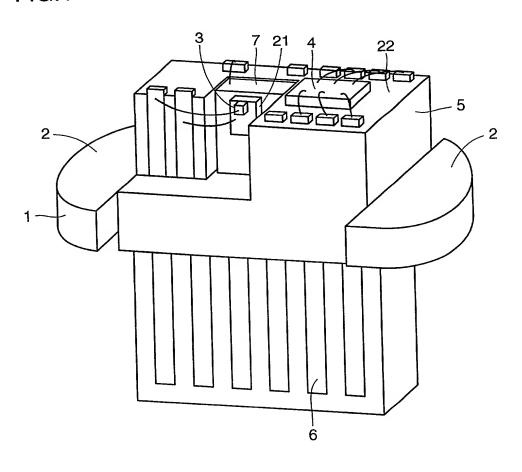
Sheet 1 of 6

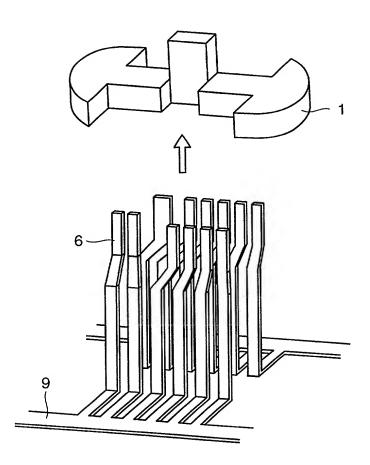
FIG.1



Inventor(s): Takahide ISHIGURO and Osamu HAMAOKA Application No.: To Be Assigned Docket No.: 245402004300

Sheet 2 of 6

## FIG.2



Title: SEMICONDUCTOR LASER PACKAGE AND FABRICATION METHOD THEREOF Inventor(s): Takahide ISHIGURO and Osamu HAMAOKA Application No.: To Be Assigned Docket No.: 245402004300

Sheet 3 of 6

FIG.3

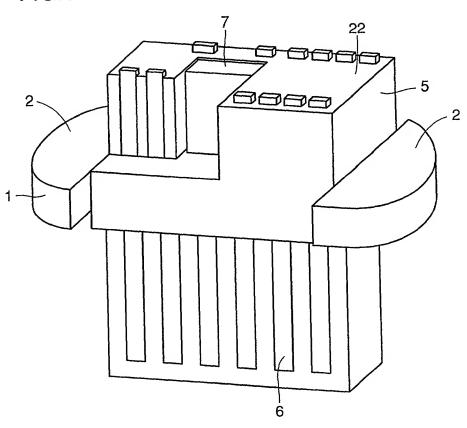
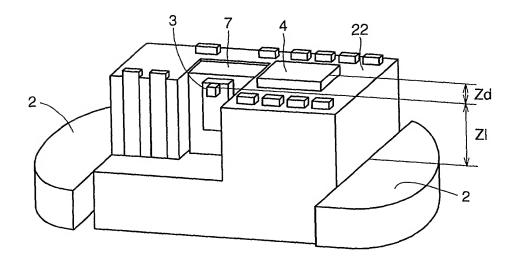


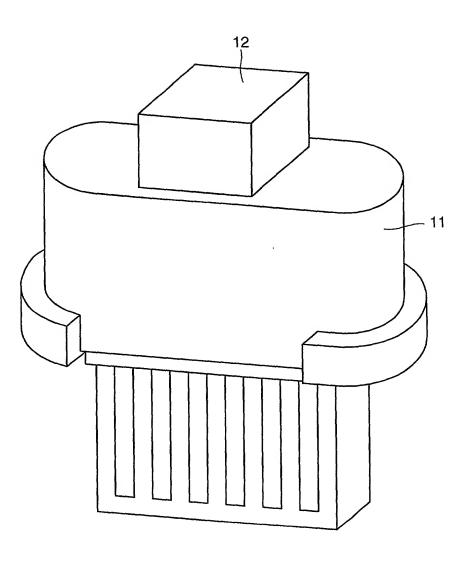
FIG.4



Title: SEMICONDUCTOR LASER PACKAGE AND FABRICATION METHOD THEREOF Inventor(s): Takahide ISHIGURO and Osamu HAMAOKA Application No.: To Be Assigned Docket No.: 245402004300

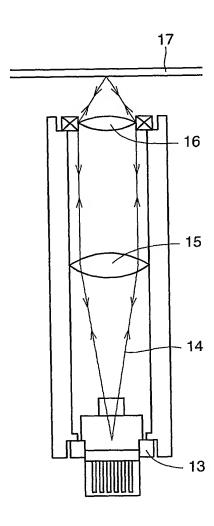
Sheet 4 of 6

FIG.5



Sheet 5 of 6

FIG.6



The state of the s

Inventor(s): Takahide ISHIGURO and Osamu HAMAOKA Application No.: To Be Assigned Docket No.: 245402004300

Sheet 6 of 6

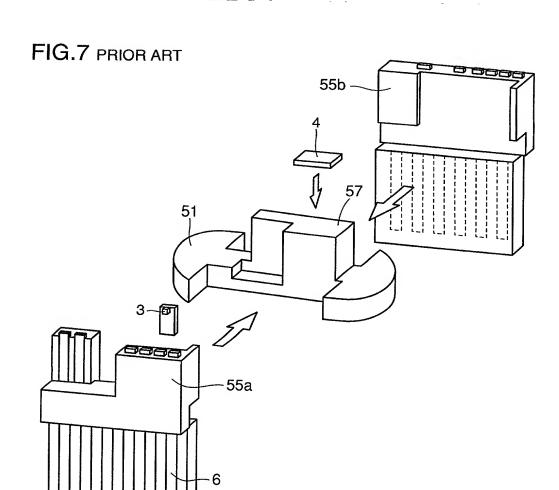


FIG.8 PRIOR ART

